

## 10-BIT, 25MSPS, 35mW A/D CONVERTER

- 10-bit A/D converter in deep submicron CMOS technology
- Ultra low power consumption: 35mW @  $25Msps$  (10mW  $@5Msps$ )
- Single supply voltage: 2.5V
- Input range: 2Vpp differential
- 25Msps sampling frequency
- ENOB=9.7 @ Nyquist
- SFDR typically up to 72dB @ Nyquist
- Built-in reference voltage with external bias capability
- STMicroelectronics 8, 10, 12 and 14-bits ADC pinout compatibility

#### **DESCRIPTION**

The TSA1001 is a 10-bit, 25Msps sampling frequency Analog to Digital converter using a CMOS technology combining high performances and very low power consumption.

The TSA1001 is based on a pipeline structure and digital error correction to provide excellent static linearity and go beyond 9.8 effective bits at Fs=25Msps, and Fin=10MHz.

Especially designed for portable applications, the TSA1001 only dissipates 35mW at 25Msps. When running at lower sampling frequencies, even lower consumption can be achieved.

A voltage reference is integrated in the circuit to simplify the design and minimize external components. It is nevertheless possible to use the circuit with an external reference.

The output data can be coded into two different formats. A Data Ready signal is raised as the data is valid on the output and can be used for synchronization purposes.

The TSA1001 is available in commercial (0 to +70°C) and extended (-40 to +85°C) temperature range, in a small 48 pins TQFP package.

#### **APPLICATIONS**

- Portable instrumentation
- Video processing
- Medical imaging and ultrasound
- High resolution fax and scanners
- Digital communications

#### **ORDER CODE**



#### **PIN CONNECTIONS** (top view)



#### **PACKAGE**



## **ABSOLUTE MAXIMUM RATINGS**



1). All voltages values, except differential voltage, are with respect to network ground terminal. The magnitude of input and output voltages must never exceed -0.3V or VCC+0V

## **OPERATING CONDITIONS**



## **BLOCK DIAGRAM**



#### **PIN CONNECTIONS** (top view)



#### **PIN DESCRIPTION**



#### **ELECTRICAL CHARACTERISTICS**

 $AVCC = DVCC = VCCB = 2.5V$ , Fs= 25Msps, Fin=1MHz, Vin@ -1.0dBFS, VREFM = 0V Tamb = 25°C (unless otherwise specified)

## **TIMING CHARACTERISTICS**



#### **TIMING DIAGRAM**



#### **CONDITIONS**:

AVCC = DVCC = VCCB = 2.5V, Fs= 25Msps, Fin= 1MHz, Vin@ -1.0dBFS, VREFM= 0V Tamb = 25°C (unless otherwise specified)

## **ANALOG INPUTS**



1). See parameters definition for more information

#### **REFERENCE VOLTAGE**



1). Not fully tested over the temperature range. Guaranted by sampling.

#### **CONDITIONS**:

AVCC = DVCC = VCCB = 2.5V, Fs= 25Msps, Fin= 1MHz, Vin@ -1.0dBFS, VREFP=1V, VREFM= 0V Tamb = 25°C (unless otherwise specified)

#### **POWER CONSUMPTION**



1). Rpol= 25KΩ. Equivalent load: Rload= 470Ω and Cload= 6pF

2). Not fully tested over the temperature range. Guaranted by sampling.

## **DIGITAL INPUTS AND OUTPUTS**



## **ACCURACY**



#### **CONDITIONS**:

AVCC = DVCC = 2.5V, Fs= 25Msps Vin@ -1.0dBFS, VREFP=1V, VREFM= 0V Tamb = 25°C (unless otherwise specified)

## **DYNAMIC CHARACTERISTICS**



1). Rpol= 25KΩ. Equivalent load: Rload= 470Ω and Cload= 6pF

2). Tmin= -40°C to Tmax= 85°C. Not fully tested over the temperature range. Guaranted by sampling.

#### **DEFINITIONS OF SPECIFIED PARAMETERS**

#### **STATIC PARAMETERS**

Static measurements are performed through method of histograms on a 2MHz input signal, sampled at 25Msps, which is high enough to fully characterize the test frequency response. The input level is +1dBFS to saturate the signal.

#### **Differential Non Linearity (DNL)**

The average deviation of any output code width from the ideal code width of 1LSB.

#### **Integral Non linearity (INL)**

An ideal converter presents a transfer function as being the straight line from the starting code to the ending code. The INL is the deviation for each transition from this ideal curve.

#### **DYNAMIC PARAMETERS**

Dynamic measurements are performed by spectral analysis, applied to an input sinewave of various frequencies and sampled at 25Msps.

#### **Spurious Free Dynamic Range (SFDR)**

The ratio between the amplitude of fundamental tone (signal power) and the power of the worst spurious signal (not always an harmonic) over the full Nyquist band. It is expressed in dBc.

#### **Total Harmonic Distortion (THD)**

The ratio of the rms sum of the first five harmonic distortion components to the rms value of the fundamental line. It is expressed in dB.

#### **Signal to Noise Ratio (SNR)**

The ratio of the rms value of the fundamental component to the rms sum of all other spectral components in the Nyquist band  $(f_s/2)$  excluding DC, fundamental and the first five harmonics. SNR is reported in dB.

#### **Signal to Noise and Distorsion Ratio (SINAD)**

Similar ratio as for SNR but including the harmonic distortion components in the noise figure (not DC signal). It is expressed in dB.

From the SINAD, the Effective Number of Bits (ENOB) can easily be deduced using the formula:  $SINAD = 6.02 \times ENOB + 1.76$  dB.

When the applied signal is not Full Scale (FS), but has an  $A_0$  amplitude, the SINAD expression becomes:

 $SINAD = 6.02 \times ENOB + 1.76 dB + 20 log (2A<sub>0</sub>/FS)$ The ENOB is expressed in bits.

#### **Analog Input Bandwidth**

The maximum analog input frequency at which the spectral response of a full power signal is reduced by 3dB. Higher values can be achieved with smaller input levels.

#### **Effective Resolution Bandwidth (ERB)**

The band of input signal frequencies that the ADC is intended to convert without loosing linearity i.e. the maximum analog input frequency at which the SINAD is decreased by 3dB or the ENOB by 1/2 bit.

#### **Pipeline delay**

Delay between time when the analog input is initially sampled and time when the corresponding digital data output is valid on the output bus. Also called data latency. It is expressed as a number of clock cycles.

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## **EQUIVALENT CIRCUITS**

## **Figure 1 : Analog Input Circuit**







## **Figure 3 :** Input buffers









**Static parameter: Integral Non Linearity** Fs=25MSPS; Fin=1MHz; Icca=11mA; N=131072pts









**Distortion vs. AVcc** Fs=25MSPS; Icca=11mA; Fin=1MHz



#### **Linearity vs. DVcc** Fs=25MSPS; Icca=11mA; Fin=1MHz **61 10 Dynamic parameters (dB)** Dynamic parameters (dB) **60.5 9.95 SNR ENOB (bits) 60 9.9** ENOB (bits) **SINAD 59.5 9.85 59 9.8 ENOB 58.5 9.75 58 9.7 2.25 2.35 2.45 2.55 2.65 DVCC (V)**

**Linearity vs. VccB** Fs=25MSPS; Icca=11mA; Fin=1MHz







**Distortion vs. DVcc** Fs=25MSPS; Icca=11mA; Fin=1MHz



## **Distortion vs. VccB** Fs=25MSPS; Icca=11mA; Fin=1MHz



**Distortion vs. Fs** Icca=11mA; Fin=1MHz





## **Linearity vs. Fs**





**Linearity vs. Fin** Fs=25MSPS; Icca=11mA









#### **Distortion vs. Fin** Fs=25MSPS; Icca=11mA

**-90 -85 -80 -75**



**5 15 25 35 45 Fs (MHz)**

**SFDR**

← - 1

**Distortion vs. Temperature** Fs=25MSPS; Icca=11mA; Fin=5MHz;



# **TSA1001 APPLICATION NOTE**

#### **DETAILED INFORMATION**

The TSA1001 is a High Speed analog to digital converter based on a pipeline architecture and the latest deep submicron CMOS process to achieve the best performances in terms of linearity and power consumption.

The pipeline structure consists of 9 internal conversion stages in which the analog signal is fed and sequencially converted into digital data.

Each 8 first stages consists of an Analog to Digital converter, a Digital to Analog converter, a Sample and Hold and a gain of 2 amplifier. A 1.5bit conversion resolution is achieved in each stage. The latest stage simply is a comparator. Each resulting LSB-MSB couple is then time shifted to recover from the conversion delay. Digital data correction completes the processing by recovering from the redundancy of the (LSB-MSB) couple for each

stage. The corrected data are outputed through the digital buffers.

Signal input is sampled on the rising edge of the clock while digital outputs are delivered on the falling edge of the Data Ready signal.

The advantages of such a converter reside in the combination of pipeline architecture and the most advanced technologies. The highest dynamic performances are achieved while consumption remains at the lowest level.

Some functionalities have been added in order to simplify as much as possible the application board. These operational modes are described in the following table.

The TSA1001 is pin to pin compatible with the 8bits/40Msps TSA0801, the 10bits/50Msps 8bits/40Msps TSA0801, the TSA1002 and the 12bits/50Msps TSA1201. This ensures a conformity within the product family and above all, an easy upgrade of the application.



#### **OPERATIONAL MODES DESCRIPTION**

#### **Data Format Select (DFSB)**

When set to low level (VIL), the digital input DFSB provides a two's complement digital output MSB. This can be of interest when performing some further signal processing.

When set to high level (VIH), DFSB provides a standard binary output coding.

#### **Output Enable (OEB)**

When set to low level (VIL), all digital outputs remain active and are in low impedance state. When set to high level (VIH), all digital outputs buffers are in high impedance state. This results in lower consumption while the converter goes on sampling.

When OEB is set to low level again, , the data is then valid on the output with a very short Ton delay.

The timing diagram summarizes this operating cycle.

#### **Out of Range (OR)**

This function is implemented on the output stage in order to set up an "Out of Range" flag whenever the digital data are over the full scale range.

Typically, there is a detection of all the data being at '0' or all the data being at '1'. This ends up with an output signal OR which is in low level state

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(VOL) when the data stay within the range, or in high level state (VOH) when the data is out of the range.

#### **Data Ready (DR)**

The Data Ready output is an image of the clock being synchronized on the output data (D0 to D9). This is a very helpful signal that simplifies the synchronization of the measurement equipment or the controlling DSP.

As digital output, DR goes in high impedance state when OEB is asserted to High level as described in the timing diagram.

#### **DRIVING THE ANALOG INPUT**

#### **Differential inputs**

The TSA1001 has been designed to obtain optimum performances when being differentially driven. An RF transformer is a good way to achieve such performances.

Figure 5 describes the schematics. The input signal is fed to the primary of the transformer, while the secondary drives both ADC inputs. The common mode voltage of the ADC (INCM) is connected to the center-tap of the secondary of the transformer in order to bias the input signal around this common voltage, internally set to 0.56V. The INCM is decoupled to maintain a low noise level on this node. Our evaluation board is mounted with a 1:1 ADT1-1 transformer from Minicircuits. You might also use a higher impedance ratio (1:2 or 1:4) to reduce the driving requirement on the analog signal source.

Each analog input can drive a 1Vpp amplitude input signal, so the resultant differential amplitude is 2Vpp.





#### **Single-ended input configuration**

Some applications may require a single-ended input which is easily achieved with the configuration reported on Figure 6.

In this case, it is recommended to use an AC-coupled analog input and connect the other analog input to the common mode voltage of the circuit (INCM) so as to properly bias the ADC. The INCM may remain at the same internal level (0.56V) thus driving only a 1Vpp input amplitude, or it must be increased to 0.9V to drive a 2Vpp input amplitude. You will get higher performances using a 2Vpp signal.





Dynamic characteristics, while not being as remarkable as for differential configuration, are still of very good quality. Measurements done at 25Msps, 1MHz input frequency, -1dBFS input level sum up these performances. An SFDR of -69.5dBc, an SNR of 59.5dB and an ENOB Full Scale of 9.7bits are achieved.

#### **REFERENCE CONNECTION**

#### **Internal reference**

In the standard configuration, the ADC is biased with the internal reference voltage. VREFM pin is connected to Analog Ground while VREFP is internally set to a voltage of 1.03V. It is recommended to decouple the VREFP in order to minimize low and high frequency noise. Refer to Figure 7 for the schematics.





#### **External reference**

It is possible to use an external reference voltage instead of the internal one for specific applications requiring even better linearity or enhanced temperature behaviour. In this case, the amplitude of the external voltage must be at least equal to the internal one (1.03V). Using the STMicroelectronics Vref TS821 leads to optimum performances when configured as shown on Figure 8.





At 15Msps sampling frequency, 1MHz input frequency and -1dBFS amplitude signal, performances can be improved of up to 2dBc on SFDR and 0.3dB on SINAD. At 25Msps sampling frequency, 1MHz input frequency and -1dBFS amplitude signal, performances can be improved of up to 1dBc on SFDR and 0.5dB on SINAD.

This can be very helpful for example for multichannel application to keep a good matching among the sampling frequency range.

#### **Clock input**

The quality of your converter is very dependant on your clock input accuracy, in terms of aperture jitter; the use of low jitter crystal controlled oscillator is recommended.

The duty cycle must be between 45% and 55%.

The clock power supplies must be separated from the ADC output ones to avoid digital noise modulation at the output.

It is recommended to always keep the circuit clocked, even at the lowest specified sampling frequency of 0.5Msps, before applying the supply voltages.

#### **Power consumption optimization**

The internal architecture of the TSA1001 enables to optimize the power consumption according to the sampling frequency of the application. For this purpose, a resistor is placed between IPOL and the analog Ground pins.

The TSA1001 will combine highest performances and lowest consumption at 25Msps when Rpol is equal to 25kΩ.

At lower sampling frequency range (< 10Msps), this value of resistor may be adjusted in order to decrease the analog current without any degradation of dynamic performances.

As an example, 10mW total power consumption is achieved at 5 Msps with Rpol equal to 390kΩ. The table below sums up the relevant data.

#### **Total power consumption optimization depending on Rpol value**



## **Layout precautions**

To use the ADC circuits in the best manner at high frequencies, some precautions have to be taken for power supplies:

- First of all, the implementation of 4 separate proper supplies and ground planes (analog, digital, internal and external buffer ones) on the PCB is mandatory for high speed circuit applications to provide low inductance and low resistance common return.

The separation of the analog signal from the digital part is essential to prevent noise from coupling onto the input signal.

- Power supply bypass capacitors must be placed as close as possible to the IC pins in order to improve high frequency bypassing and reduce harmonic distortion.

- Proper termination of all inputs and outputs must be incorporated with output termination resistors; then the amplifier load will be only resistive and the stability of the amplifier will be improved. All leads must be wide and as short as possible especially for the analog input in order to decrease parasitic capacitance and inductance.

- To keep the capacitive loading as low as possible at digital outputs, short lead lengths of routing are essential to minimize currents when the output changes. To minimize this output capacitance, buffers or latches close to the output pins will relax this constraint.

- Choose component sizes as small as possible (SMD).

#### **EVAL1002 evaluation board**

The characterization of the board has been made with a fully ADC devoted test bench as shown on Figure 10. The analog signal must be filtered to be very pure.

The dataready signal is the acquisition clock of the logic analyzer.

The ADC digital outputs are latched by the octal buffers 74LCX573.

All characterization measurements have been made with: SFSR=+0.2dB for static parameters.-SFSR=-0.5dB for dynamic parameters.

**Figure 9 :** Analog to Digital Converter characterization bench











## **Printed circuit board - List of components**



#### **PACKAGE MECHANICAL DATA** 48 PINS - PLASTIC PACKAGE





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